

Title (en)

CONDUCTOR COUPLING ARRANGEMENT FOR COUPLING CONDUCTORS

Title (de)

LEITERBAHNKOPPLUNGSANORDNUNG ZUR KOPPLUNG VON LEITERN

Title (fr)

AGENCEMENT DE COUPLAGE DE CONDUCTEUR POUR LE COUPLAGE DE CONDUCTEURS

Publication

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Application

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Priority

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Abstract (en)

The present invention provides a conductor coupling arrangement 100 for coupling conductors 101, 102, comprising a first conductor 101, and a second conductor 102, wherein a protrusion 103, formed of conductive material on the first conductor 101, extends essentially perpendicular to a longitudinal extension of the first conductor 101, and wherein at least one coupling surface 103a of the protrusion 103 is separated from a coupling portion 104 of the second conductor 102 by at least a dielectric material 105, forming a capacitive coupling between the first conductor 101 and the second conductor 102.

IPC 8 full level

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CPC (source: EP)

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Citation (applicant)

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- US 7629944 B2 20091208 - LENART GREGOR [SE], et al
- US 2012256794 A1 20121011 - VEIHL JONATHON C [US], et al

Citation (search report)

- [XYI] US 5156559 A 19921020 - SOMMER ERNST [DE], et al
- [YDA] US 2012256794 A1 20121011 - VEIHL JONATHON C [US], et al
- [XA] "Method for Implementing an AC Capacitively-Coupled Interconnect Using Coaxial PTH Vias in Organic Packages", IP.COM JOURNAL, IP.COM INC., WEST HENRIETTA, NY, US, 17 June 2010 (2010-06-17), XP013138699, ISSN: 1533-0001

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